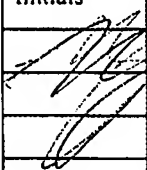
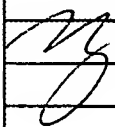


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**INFORMATION DISCLOSURE  
STATEMENT BY APPLICANT**Sheet 1 of 2Application Number.: UnassignedFiling Date: HerewithFirst Named Inventor: Kuczynski et alArt Unit: UnassignedExaminer Name: UnassignedAttorney Docket Number.: ROC920040017US1**U.S. PATENT DOCUMENTS**

Examiner Initials*	Cite No. <sup>1</sup>	Document Number Number - Kind Code <sup>2</sup> (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns or Lines Where Relevant Passages or Figs. Appear
	AA	US - 6264476B1	07/24/2001	Che-yu Li et al	
	AB	US - 6528984B2	03/04/2003	Brian Samuel Beaman et al	

**FOREIGN PATENT DOCUMENTS**

Examiner Initials	Cite No. <sup>1</sup>	Foreign Patent Document Country <sup>3</sup> - Number <sup>4</sup> - Kind Code <sup>5</sup> Code (if known)	Publication Date MM-DD- YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns or Lines Where Relevant Passages or Figs. Appear	T <sup>6</sup>
	AC	JP -11 - 31541 - A	02/02/1999	Kawabe		X

Examiner Signature		Date Considered	4/25/05
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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

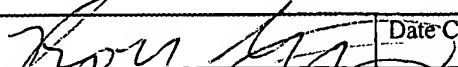
<sup>1</sup> Applicant's unique citation designation number (optional). <sup>2</sup> See Kind Codes of USPTO Patent Documents at [www.uspto.gov](http://www.uspto.gov) or MPEP 901.04. <sup>3</sup> Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3).

<sup>4</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. <sup>6</sup> Applicant is to place a check mark here if English language translation is attached.

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**INFORMATION DISCLOSURE  
STATEMENT BY APPLICANT**Sheet 2 of 2Application Number.: UnassignedFiling Date: HerewithFirst Named Inventor: Kuczynski et alArt Unit: UnassignedExaminer Name: UnassignedAttorney Docket Number.: ROC920040017US1**OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS**

Examiner Initials	Cite No. <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and or country where published.	T <sup>2</sup>
Mg	AD	IBM Technical Disclosure Bulletin, Vol. 33, No. 5, October 1990, "Compressible- Contact Interconnection Scheme" by K. J. Puttlitz and H. Wenskus, pp. 394-395	
	AE	US Patent Application Publication 2001/0001748A1, May 24, 2001, "Conduction Assist Member and Manufacturing Method of the Same" by Toshimasa Ochiai	
/	AF	US Patent Application Publication 2001/0020546A1, September 13, 2001, "Electrical Contact Structures Formed by Configuring a Flexible Wire to Have a Springable Shape And Overcoating the Wire With at Least One Layer of a Resilient Conductive Material, Methods of Mounting the Contact Structures to Electronic Components, and Applications for Employing the Contact Structures" by Benjamin N. Eldridge et al	
	AG	US Patent Application Publication 2001/0024892A1, September 27, 2001, "Contact Sheet" by Toshimasa Ochiai	
	AH	US Patent Application Publication 2003/0146510A1, August 7, 2003, "Elastomer Interposer for Grid Array Packages and Method of Manufacturing the Same" by Ray Chien	
	AI	US Patent Application Publication 2003/0003784A1, January 2, 2003, "Interposer Assembly" by Douglas A. Neidich	

Examiner Signature		Date Considered	7/25/05
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<sup>1</sup> Applicant's unique citation designation number (optional).

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